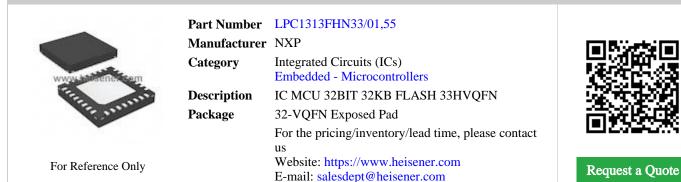


LPC1313FHN33/01,55

LPC1313FHN33/01,55 Information



Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



LPC1313FHN33/01,55 Specifications

Manufacturer Part Number	LPC1313FHN33/01,55
Manufacturer	NXP
Category	Integrated Circuits (ICs)
	Embedded - Microcontrollers
Package	32-VQFN Exposed Pad
Series	LPC13xx
Core Processor	ARM? Cortex?-M3
Core Size	32-Bit
Speed	72MHz
Connectivity	I2C, Microwire, SPI, SSI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	28
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2 V ~ 3.6 V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	-
Package / Case	32-VQFN Exposed Pad
Supplier Device Package	32-HVQFN (7x7)
	Report errors?

LPC1313FHN33/01,55 Guarantees



Quality Guarantees

We provide 90 days warranty. * If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

SERVICE BUARANTEE

Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

LPC1313FHN33/01,55 Payment Methods





If you have any question about LPC1313FHN33/01,55, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com